Designation: E407 – 07 (Reapproved 2015) $^{\epsilon 1}$

Standard Practice for Microetching Metals and Alloys¹

This standard is issued under the fixed designation E407; the number immediately following the designation indicates the year of original adoption or, in the case of revision, the year of last revision. A number in parentheses indicates the year of last reapproval. A superscript epsilon (ε) indicates an editorial change since the last revision or reapproval.

This standard has been approved for use by agencies of the U.S. Department of Defense.

ε¹ NOTE—Originally approved date was editorially corrected to 1970 in footnote 1 in January 2016.

1. Scope

- 1.1 This practice covers chemical solutions and procedures to be used in etching metals and alloys for microscopic examination. Safety precautions and miscellaneous information are also included.
- 1.2 This standard does not purport to address all of the safety concerns, if any, associated with its use. It is the responsibility of the user of this standard to establish appropriate safety and health practices and determine the applicability of regulatory limitations prior to use. For specific cautionary statements, see 6.1 and Table 2.

2. Referenced Documents

- 2.1 ASTM Standards:²
- D1193 Specification for Reagent Water
- E7 Terminology Relating to Metallography
- E2014 Guide on Metallographic Laboratory Safety

3. Terminology

- 3.1 Definitions:
- 3.1.1 For definition of terms used in this standard, see Terminology E7.
 - 3.2 Definitions of Terms Specific to This Standard:
- 3.2.1 *tint etch*—an immersion etchant that produces color contrast, often selective to a particular constituent in the microstructure, due to a thin oxide, sulfide, molybdate, chromate or elemental selenium film on the polished surface that reveals the structure due to variations in light interference effects as a function of the film thickness (also called a "stain etch").

3.2.2 vapor-deposition interference layer method— a technique for producing enhanced contrast between microstructural constituents, usually in color, by thin films formed by vacuum deposition of a dielectric compound (such as ZnTe, ZnSe, TiO₂, ZnS or ZnO) with a known index of refraction, generally due to light interference effects (also known as the "Pepperhoff method").

4. Summary of Practice

- 4.1 Table 1 is an alphabetical listing of the metals (including rare earths) and their alloys for which etching information is available. For each metal and alloy, one or more etchant numbers and their corresponding use is indicated. Alloys are listed as a group or series when one or more etchants are common to the group or series. Specific alloys are listed only when necessary. When more than one etchant number is given for a particular use, they are usually given in order of preference. The numbers of electrolytic etchants are *italicized* to differentiate them from nonelectrolytic etchants.
- 4.2 Table 2 is a numerical listing of all the etchants referenced in Table 1 and includes the composition and general procedure to be followed for each etchant.
- 4.3 To use the tables, look up the metal or alloy of interest in Table 1 and note the etchant numbers corresponding to the results desired. The etchant composition and procedure is then located in Table 2corresponding to the etchant number.
- 4.4 If the common name of an etchant is known (Marble's, Vilella's, etc.), and it is desired to know the composition, Table 3contains an alphabetical listing of etchant names, each coded with a number corresponding to the etchant composition given in Table 2.

5. Significance and Use

5.1 This practice lists recommended methods and solutions for the etching of specimens for metallographic examination. Solutions are listed to highlight phases present in most major alloy systems.

6. Safety Precautions

6.1 Before using or mixing any chemicals, all product labels and pertinent Material Safety Data Sheets (MSDS) should be

¹ This practice is under the jurisdiction of ASTM Committee E04 on Metallography and is the direct responsibility of Subcommittee E04.01 on Specimen Preparation.

Current edition approved June 1, 2015. Published September 2015. Originally approved in 1970. Last previous edition approved in 2007 as E407–07^{e1}. DOI: 10.1520/E0407-07R15E01.

² For referenced ASTM standards, visit the ASTM website, www.astm.org, or contact ASTM Customer Service at service@astm.org. For *Annual Book of ASTM Standards* volume information, refer to the standard's Document Summary page on the ASTM website.

read and understood concerning all of the hazards and safety precautions to be observed. Users should be aware of the type of hazards involved in the use of all chemicals used, including those hazards that are immediate, long-term, visible, invisible, and with or without odors. See Guide E2014 on Metallographic Laboratory Safety for additional information on; Chemical Safety, Electrolytic Polishing/Etching and Laboratory Ventilation/Fume Hoods.

- 6.1.1 Consult the product labels and MSDSs for recommendations concerning proper protective clothing.
- 6.1.2 All chemicals are potentially dangerous. All persons using any etchants should be thoroughly familiar with all of the chemicals involved and the proper procedure for handling, mixing, and disposing of each chemical, as well as any combinations of those chemicals. This includes being familiar with the federal, state, and local regulations governing the handling, storage, and disposal of these chemical etchants.
- 6.2 Some basic suggestions for the handling and disposing of etchants and their ingredients are as follows:
- 6.2.1 When pouring, mixing, or etching, always use the proper protective equipment, (glasses, gloves, apron, etc.) and it is strongly recommended to always work under a certified and tested fume hood. This is imperative with etchants that give off noxious odors or toxic vapors that may accumulate or become explosive. In particular, note that solutions containing perchloric acid must be used in an exclusive hood equipped with a wash down feature to avoid accumulation of explosive perchlorates. See Guide E2014 on Metallographic Laboratory Safety for additional information on safety precautions for electrolytes containing perchloric acid..
- 6.2.2 No single type of glove will protect against all possible hazards. Therefore, a glove must be carefully selected and used to ensure that it will provide the needed protection for the specific etchant being used. In some instances it may be necessary to wear more than one pair of gloves to provide proper protection. Information describing the appropriate glove may be obtained by consulting the MSDS for the chemical being used. If that does not provide enough detailed information, contact the chemical manufacturer directly. Additionally, one can contact the glove manufacturer or, if available, consult the manufacturers glove chart. If the chemical is not listed or if chemical mixtures are being used, contact the glove manufacturer for a recommendation.
- 6.2.3 Use proper devices (glass or plastic) for weighing, mixing, containing, and storage of solutions. A number of etchants generate fumes or vapors and should only be stored in properly vented containers. Storage of fuming etchants in sealed or non-vented containers may create an explosion hazard.
- 6.2.4 When mixing etchants, always add reagents to the solvent unless specific instructions indicate otherwise.
- 6.2.5 When etching, always avoid direct physical contact with the etchant and specimen; use devices such as tongs to hold the specimen (and tufts of cotton, if used).
- 6.2.6 Methanol is a cumulative poison hazard. Where ethanol or methanol, or both are listed as alternates, ethanol is the preferred solvent. Methanol should be used in a properly designed chemical fume hood.

- 6.2.7 When working with HF always be sure to wear the appropriate gloves, eye protection and apron. Buying HF at the lowest useable concentration will significantly reduce risk. Additionally, it is recommended that a calcium gluconate cream or other appropriate HF neutralizing agent be available for use if direct skin contact of the etchant occurs.
- 6.2.8 The EPA states that human studies have clearly established that inhaled chromium (VI) is a human carcinogen, resulting in an increased risk of lung cancer. Animal studies have shown chromium (VI) to cause lung tumors via inhalation exposure. Therefore, when working with Cr(VI) compounds such as $K_2Cr_2O_7$ and CrO_3 always use a certified and tested fume hood. Additional information can be obtained at the EPA website³.
- 6.2.9 For safety in transportation, picric acid is distributed by the manufacturer wet with greater than 30% water. Care must be taken to keep it moist because dry picric acid is shock sensitive and highly explosive especially when it is combined with metals such as copper, lead, zinc, and iron. It will also react with alkaline materials including plaster and concrete to form explosive compounds. It should be purchased in small quantities suitable for use in six to twelve months and checked periodically for lack of hydration. Distilled water may be added to maintain hydration, It must only be stored in plastic or glass bottles with nonmetallic lids. If dried particles are noted on or near the lid, submerge the bottle in water to re-hydrate them before opening. It is recommended that any bottle of picric acid that appears dry or is of unknown vintage not be opened and that proper emergency personnel be notified.
- 6.2.10 Wipe up or flush any and all spills, no matter how minute in nature.
- 6.2.11 Properly dispose of all solutions that are not identified by composition and concentration.
- 6.2.12 Store, handle and dispose of chemicals according to the manufacturer's recommendations. Observe printed cautions on reagent bottles.
- 6.2.13 Information pertaining to the toxicity, hazards, and working precautions of the chemicals, solvents, acids, bases, etc. being used (such as material safety data sheets, MSDS) should be available for rapid consultation. A selection of useful books on this subject is given in Refs. (1-11)⁴.
- 6.2.14 Facilities which routinely use chemical etchants should have an employee safety training program to insure the employees have the knowledge to properly handle chemical etchants.
- 6.2.15 When working with etchants always know where the nearest safety shower, eye-wash station, and emergency telephone are located.

7. Miscellaneous Information

- 7.1 If you know the trade name of an alloy and need to know the composition to facilitate the use of Table 1, refer to a compilation such as Ref (12).
- 7.2 Reagent grade chemicals shall be used for all etchants. Unless otherwise indicated, it is intended that all reagents

³ http://www.epa.gov/ttn/atw/hlthef/chromium.html

⁴ The **boldface** numbers in parentheses refer to the list of references at the end of this standard.

conform to specifications of the Committee on Analytical Reagents of the American Chemical Society where such specifications are available. Other grades, such as United States Pharmacopeia (USP), may be used, provided it is first ascertained that the reagent is of sufficiently high purity to permit its use without detrimental effect.

- 7.2.1 Unless otherwise indicated, references to water shall be understood to mean reagent water as defined by Type IV of specification D1193. Experience has shown that the quality of tap water varies significantly and can adversely affect some etchants.
- 7.3 Methanol is usually available only as absolute methanol. When using this alcohol it is imperative that approximately 5 volume % of water is added whenever an etchant composition calls for 95 % methanol. Some of these etchants will not work at all if water is not present.
- 7.4 For conversion of small liquid measurements, there are approximately 20 drops/mL.
- 7.5 Etching should be carried out on a freshly polished specimen.
- 7.6 Gentle agitation of the specimen or solution during immersion etching will result in a more uniform etch.
- 7.7 The etching times given are only suggested starting ranges and not absolute limits.
- 7.8 In electrolytic etching, d-c current is implied unless indicated otherwise.
- 7.9 A good economical source of d-c current for small scale electrolytic etching is the standard 6-V lantern battery.
- 7.10 In electrolytic etching, the specimen is the anode unless indicated otherwise.
- 7.11 Do not overlook the possibility of multiple etching with more than one solution in order to fully develop the structure of the specimen.
- 7.12 Microscope objectives can be ruined by exposure to hydrofluoric acid fumes from etchant residue inadvertently left on the specimen. This problem is very common when the specimen or mounting media contain porosity and when the mounting material (such as Bakelite) does not bond tightly to the specimen resulting in seepage along the edges of the specimen. In all cases, extreme care should be taken to remove all traces of the etchant by thorough washing and complete drying of the specimen before placing it on the microscope stage.

- 7.13 Tint etchants (13, 14-16) are always used by immersion, never by swabbing, as this would inhibit film formation. An extremely high quality polish is required as tint etchants will reveal remaining polishing damage even if it is not visible with bright field illumination. After polishing, the surface must be carefully cleaned. Use a polyethylene beaker to contain the etchant if it contains fluorine ions (for example, etchants containing ammonium bifluoride, NH₄ FHF). The specimen is placed in the solution using tongs, polished face up. Gently agitate the solution while observing the polished surface. After coloration begins, allow the solution to settle and remain motionless. Remove the specimen from the etchant when the surface is colored violet, rinse and dry. A light pre-etch with a general-purpose chemical etchant may lead to sharper delineation of the structure after tint etching.
- 7.14 Specimens should be carefully cleaned before use of a vapor-deposition interference film ("Pepperhoff") method (13, **14-17**). A light pre-etch, or a slight amount of polishing relief, may lead to sharper delination of the constituents after vapor deposition. The deposition is conducted inside a vacuum evaporator of the type used to prepare replicas for electron microscopy. One or several small lumps of a suitable dielectric compound with the desired index of refraction is heated under a vacuum until it evaporates. A vacuum level of 1.3 to 0.013 Pa $(10^{-3} \text{ to } 10^{-5} \text{ mm Hg})$ is adequate and the polished surface should be about 10-15 cm beneath the device that holds the dielectric compound. Slowly evaporate the lumps and observe the surface of the specimen. It may be helpful to place the specimen on a small piece of white paper. As the film thickness increases, the surface (and the paper) will become colored with the color sequence changing in the order vellow, green, red, purple, violet, blue, silvery blue. Stop the evaporation when the color is purple to violet, although in some cases, thinner films with green or red colors have produced good results.
- 7.15 Metals Handbook (18) provides additional advice on etching solutions and techniques for various alloys.

8. Precision and Bias

8.1 It is not possible to specify the precision or bias of this practice since quantitative measurements are not made.

9. Keywords

9.1 etch; etchant; interference method; metallography; metals; microetch; microscope; microstructure; Pepperhoff method; tint etch

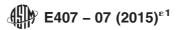


TABLE 1 Etchants for Metals

Note 1—It is strongly recommended to always mix and use etchants under a certified and tested fume hood.

Note 2—Electrolytic etchants are italicized.

	Metal	Etchants	Uses
tominom Bases			
Aluminum Base:	Pure Al	1a, 2, 3	general structure
	1 410 7 11	4, 5	grain structure under polarized light
		1b	grain boundaries and slip lines
	1000 series	1a, 3, 2	gonoral structure
	1000 selles	4, 5	general structure grain structure under polarized light
		6, 7	phase identifications
		U , <i>I</i>	priase identifications
	2000 series	3, 2, 1a	general structure
		8a, 6, 7	phase identifications
	3000 series	3, 1a	general structure
		4, 5	grain structure under polarized light
		8a, 6, 7	phase identifications
	4000 series	3, 1a	general structure
	5000i		-
	5000 series	3, 1a, 2, 6, 8a <i>4</i> , 5	general structure grain structure under polarized light
		7 , U	gram structure under polarized light
	6000 series	3, 1a, 2, 6, 8a, 222	general structure
		4, 5	grain structure under polarized light
		1a, 2, 7, 6, 8a	phase identifications
	7000 series	3, 1a, 2	general structure
		4, 5	grain structure under polarized light
		3b, 6	phase identifications
Pandlium Pass:			
Beryllium Base:	Pure Be	9, 10	general structure via polarized light
	Be alloys	11	general structure
Ohrami: D		10, 120	annoval atmesture
Chromium Base:		12, <i>13c</i>	general structure
Cobalt Base:			
	Pure Co	14, 15, 16, 17	general structure
	-facing and tool metals	18, 19, 20	general structure
Hiç	gh-temperature alloys	20, 18, 16, 21, 22b, 24, 25	general structure
		19	phase identification
Columbium Base	(see niobium base)		
Copper Base:			
	Pure Cu	26, 27, 28, 29, 30, 31d, 32, 33, 34b, 35,	general structure
		36, 37, 38, 39, 40, 41, 42, <i>8b</i> , 210, 215	
		43, 28	chemical polish and etch
Cu-A	Al (aluminum bronze)	44, 31d, 34b, 35, 36, 37, 38, 39, 40,	general structure
	,	45, 215	· ·
	Cu-Be	46, 41, 45	general structure
	Cu-Cr	41	general structure
	Cu-Mn	41	general structure
	Cu-Ni	34, 47, 48, 40, 49, 50	general structure
C	Cu-Si cu-Sn (tin bronze)	41 51, 52	general structure general structure
	- (ga. o o
	Admiralty metal	8b	general structure
	Gilding metal Cartridge brass		
	ree-cutting brass		
r	Nickel silver	31d, 32, 33, 41, 42, 49	general structure
	0 "		, and the second
	Cu alloys	26, 27, 28, 29, 30, 44, 41, 31d, 32, 33,	general structure
		34b, 35, 36, 37, 38, 39, 210, 215 53, 43, 28, <i>49</i>	chemical polish and etch
		53, 43, 28, 49 42, 49, 210	darkens beta in alpha-beta brass
		54	etching of cold worked brass
_	Dysprosium Base:	55, 56	general structure

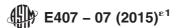


	TABLE 1 Continued	
Metal	Etchants	Uses
Erbium Base:	55, 56	general structure
Gadolinium Base:	55, 56, 57	general structure
Germanium Base:		=
Germanium base.	58, 59, 60	general structure
Gold Base:		
Pure Au	61, 62	general structure
i die Ad	63	
		chemical polish and etch
Au alloys	64b, 62	general structure
	63	chemical polish and etch
>90 % noble metals	61	general structure
<90 % noble metals	65	general structure
	00 07 00 00 70	
Hafnium base:	66, <i>67, 68, 69</i> , 70	general structure
	71	grain structure under polarized light
	72	chemical polish and etch
	55.50	
Holmium Base:	55, 56	general structure
Iridium Base:	73c	general structure
Iron Base:	74	musting to 10.00
Pure Fe	74a	grain boundaries
	75 210	substructure
	210	colors ferrite grains
F 0	70 74 77 70 70	
Fe + C	76, 74a, 77, 78, 79	general structure
and	74a, 77, 31a, 223	ferrite grain boundaries
Fe + $<1C + <4$ % additions	80, 81, 82	prior austenitic grain boundaries in martensitic and
		bainitic steels
	78, 222a	untempered martensite
	31b, 78	carbides and phosphides (matrix darkened, carbides
	015, 70	and phosphides remain bright)
	83	cementite attacked rapidly, sustenite less, ferrite and
	03	
	0.4	iron phosphide least
	84	overheating and burning
	85	stains carbides
	86	chemical polish-etch
	210, 211	colors ferrite
	213, 214	colors carbides
	216	colors lath martensite in low-carbon high-alloy grades
	222b	for dual phase steels; reveals pearlite, darkens
		martensite and outlines austenite
Fe + 4-12 Cr	80, 87, 88, 89, 90, 91, 79, 210	general structure
	86	chemical polish-etch
Fe + 12-30 Cr + <6 Ni (400 Series)	80, 87, 88, 89, 34, 40, 92, <i>93</i> , 94, 95, 91, 226	general structure
	<i>96</i> , <i>97</i> , 98	signs phase
	31c	carbides
	86	chemical polish-etch
	219	grain boundary etch
	220	darkens delta ferrite
Fe + 12-20 Cr + 4-10 Ni + <7 %	80, <i>31c</i> , 89, 99, 100, 91	general structure
		carbides
other elements (controlled trans-	31c	
formation, precipitation harden-	86 220	chemical polish-etch darkens delta ferrite
ing, stainless maraging alloys)	220	darkens della lernie
Fe + 15-30 Cr + 6-40 Ni + <5 %	<i>13b</i> , 89, 87, 88, <i>83a</i> , 80, 94, 95, 91,	general structure
other elements (300 Series)	101, 212, 221, 226	general structure
other elements (300 Series)		
	<i>13a, 102,</i> 31c, 48c, 213	carbides and sensitization
and	<i>48, 96, 97</i> , 98	stains sigma phase
Fe + 16-25 Cr + 3-6 Ni + 5-10	103, 104, 98	delineates sigma phase and
Mn (200 series)	103, 104	welds of dissimilar metals
	86	chemical polish-etch
	219	grain boundary etch (no twins)
	220	darkens delta ferrite
High temperature	89, 25, 105, 106, <i>97, 212, 221</i>	general structure
• 1	107, 108, 213	γ' precipitate
	86	chemical polish-etch
		The state of the s
Nonstainless maraging steels	109 89 99 100 221	general structure
Nonstainless maraging steels	109, 89, 99, 100, 221	general structure
Nonstainless maraging steels	109, 89, 99, 100, 221 <i>83b</i> 86	general structure grain boundaries chemical polish-etch

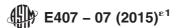
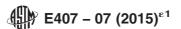


	TABLE 1 Continued	
Metal	Etchants	Uses
Tool steels	74a, 80, 14	general structure
	110	grain boundaries in tempered tool steel
	210, 211	colors ferrite, lower alloy grades
	214, 214	colors cementite
	224, 225	carbides attacked and colored
Superalloys	86, 87, 94, 221, 226	general etch
	111	general structure
	111	γ' depletion
Lead Base:		
Pure Pb	57, 112	general structure
	113	for alternate polishing and etching
DI 0.01	444 445 57 741	
Pb + <2 Sb	114, 115, 57, 74b	general structure
DI 0.01	113	for alternate polishing and etching
Pb + >2 Sb	114, 57, 74b	general structure
	113	for alternate polishing and etching
Pb + Ca	112	general structure
<u> </u>	113	for alternate polishing and etching
Pb alloys	116, 117b	general structure
Babbitt	74b	general structure
Magnesium Base:		
Pure Mg	118, 119, 74a, 120, 121, 122	general structure
	123	stain-free polish-etch
Mg-Mn	119, 74a, 124, 122	general structure
Mg-Al, Mg-Al-Zn (Al + Zn <5 %)	118, 119, 74a, 125, 124, <i>123</i> , 122	general structure
	120, 125, 126, 127	phase identification
	124, 126, 127	grain structure
Mg-Al, Mg-Al-Zn (Al $+$ Zn $>$ 5 %)	118, 119, 74a, 125, 124, 121, 122	general structure
	120, 125, 126, 127	phase identification
Mg-Zn-Zr	118, 119, 74a, 1d, 128, 124, 126,	general structure
and	127, 121, 122	
Mg-Zn-Th-Zr	120, 121	phase identification
Mg-Th-Zr	118, 119, 74a, 1d, 124, 127, 121, 122	general structure
and		
Mg-Rare Earth-Zr	120, 121	phase identification
Molybdenum Base:	98c, 129, 130, <i>131</i>	general structure
As cast	132a	chemical polish prior to etching
Nickel Base:		
Pure Ni and high Ni alloys	133, 134, 47, 135, 136, 25, 108, 31c	general structure
	137	grain boundary sulfidation
Ni-Ag	38, 138, 50, 139	general structure
Ni-Al	<i>50</i> , 140, 141, <i>142</i> , 89, 143	general structure
Ni-Cr	144, 50, <i>83, 134, 145</i> , 98, 146, 147, <i>13a</i>	general structure
Ni-Cu	38, 138, 50, 133, 140, 25, <i>134</i> , 47,	general structure
	48b, 94, 108, 34	
A11 E		
Ni-Fe	<i>50</i> , 140, 141, <i>83</i> , <i>134</i> , 148, 40, 107, 149	general structure
	74e, 25, 150	orientation pitting
Ni-Mn	74e	general structure
Ni-Mo	143	general structure
Ni-Ti	143, 151, 50, 133	general structure
Ni-Zn	152	general structure
0 "		
Superalloys	94, 105, 138, 153, 12, 87, 89, 212, 226	general structure
	25, 94	grain size
	107, 111, <i>13a</i>	reveals microstructural inhomogeneity
	133	grain boundary sulfidation
	154	fine precipitation structure
	<i>19b</i> , 155, 156	differential matrix and nonmetallic staining
	22a	for passive alloys (for example, UNS Alloy N06625)
	157	specific for UNS Alloy N10004
	107	submicroscopic structure in aged super-alloys particu-
		larly for electron microscopy. Stains the matrix when γ'
		precipitates are present
	154	γ' banding
	18	pre-etch activation for passive specimens
	213	colors carbide and γ'



Palladium Base: 9 ture Pd alloys 161, 166, 62, 165a a general structure general structure general structure general structure general structure general structure. >90 % noble metals 61 general structure. 400 % noble metals 65 general structure. Platinum Base: 64a, 73a general structure. general structure. Pure Pt 64a, 73a general structure. general structure. PV Alloys 64b, 73a general structure. general structure. 90 % noble metals 61 general structure. general structure. 490 % noble metals 65 general structure. general structure. 90 % noble metals 65 general structure. general structure. 90 % noble metals 65 general structure. general structure. Plutonium Base: 168 general structure. general structure. Phutonium Base: 13b, 98c, 132b, 170a general structure. general structure. Ruthenium Base: 13b, 98c, 132b, 170a general structure. general structure. Pure Ag 172, 173, 62 general structure. general structure. Ag-Pd alloys 173, 176 general structure. general structure. Pure Ta <t< th=""><th>Metal</th><th>Etchants</th><th>Uses</th></t<>	Metal	Etchants	Uses
164, 199, 160 grain boundaries Grain boundari			
Palledium Base: Fig. 156, 527, 1655 Pure Pri	Niobium (Columbium) Base:		•
Palledium Base: Fig. 156, 527, 1655 Pure Pri	Osmium Base:	165a	general structure
Pure Pd Interpor 61, 166, 62, 765s general structure year Pd Interpor 166, 64a, 73a general structure general structure general structure Pathrum Base: 167 general structure electroylic polish and etch general structure PH Alloys 64a, 73a general structure electroylic polish and etch general structure -90 % noble metals 61 general structure general structure -90 % noble metals 65 general structure -90 % noble metals 61 general structure -90 % noble metals 65 general structure -90 % noble metals 61 general structure	OSIMAIN Base.		etch-polishing for viewing grains with polarized lig
Pot alloys 166, 64a, 62, 165a general structure 9:00 % noble metals 65 general structure 9:00 % noble metals 61 general structure 9:00 % noble metals 61 general structure 9:00 % noble metals 61 general structure 9:00 % noble metals 65 general structure 9:00 % noble metals 9:00 %	Palladium Base:		
\$90 % noble metals	Pure Pd	61, 166, 62, <i>165a</i>	general structure
### Puterium Base: Pure Pt Patinum Base: Pure Pt Patinum Base: Pure Pt Patinum Base: Pure Pt Patinum Base: Pure Pt Patinum Base: Pure Pt Patinum Base: Pure Pt Patinum Base: Pure Pt Patinum Base: Pure Pt Patinum Base: Pure Pt Patinum Base: Pure Pt Puterium Base: Pure Pt P	Pd alloys	166, 64a, 62, <i>165a</i>	general structure
Puter Pute			general structure
Pure Pt 164, 73a general structure 167	<90 % noble metals	65	general structure
Pt Alloys			
Pt Alloys 167 167 168 celectrolytic poleh and etch >90 % noble metals <0 % noble metals €0 % noble metals €1 % noble noble €1 % noble noble €1 % noble noble €1 % noble noble	Pure Pt		
167 electrolytic polish and etch	-		
>90 % noble metals <0 % noble metals <0 % noble metals PP-10 % Rh 168 Putonium Base: Rhentum Base: 150, 96c, 132b, 170a Rhentum Base: 170b Rhothum Base: 171 Ruthentum Base: 172 Ruthentum Base: 173b Ruthentum Base: Pure Ag Ag alloys 65, 61, 174, 175, 62 Ag-Qualloys Ag-Pd alloys 173 Ag-Pd alloys 173 Ag-Bodders Pure Ta Tantalum Base: Pure Ta Tantalum Base: Pure Ta Tantalum Base: Pure Th 159, 66, 178, 163, 161, 179 Tantalum Base: Pure Th 164 Rose Pure Th 165 Rose Pure Th 164 Rose Pure Th 185 Rose Pure Th 181 Sh-Cd 74d, 180, 151 Sh-Cd Sh-Fe 182, 183, 74b Rose Sh-Fe 182, 183, 74b Rose Sh-Fe 182, 183, 74b Rose Sh-Fe Ro	Pt Alloys		
490 % noble metals		167	electrolytic polish and etch
Pi-10 % Rh 168 general structure			
Plutonium Base: 169 general structure Rhenium Base: 13b, 98c, 132b, 170a general structure grain boundaries general structure grain boundaries grain boundaries grain boundaries grain boundaries general structure grain boundaries grain boundaries general structure			S S S S S S S S S S S S S S S S S S S
Rhenium Base: 12b, 98c, 132b, 170a general structure general structure general structure general structure general structure general structure etch-polishing for viewing grains with polarized ii general structure etch-polishing for viewing grains with polarized ii general structure general structure general structure and galloys 172, 173, 62 general structure grain boundaries—retains carbide precipitate grain boundaries and inclusions grain boundaries and inclusions grain boundaries—retains carbide precipitate grain grain boundaries and inclusions grain boundaries—retains carbide precipitate grain grain boundaries—retains carbide precipitate grain grain boundaries—retains carbide precipitate grain boundaries—retains carbide	Pt-10 % Rh	168	general structure
## Rhodum Base: 171 general structure general structure gene			general structure
Ruthenium Base: 73b general structure			
Silver Base: Pure Ag	Rhodium Base:	171	general structure
Silver Base: 172, 173, 62 general structure Ag alloys 65, 61, 174, 175, 62 general structure grain boundaries and inclusions grain boundaries and inclusions grain boundaries general structure general stru	Ruthenium Base:	73b	•
Pure Ag 172, 173, 62 general structure Ag alloys 65, 61, 174, 175, 62 general structure Ag-Q-Cu alloys 130 general structure Ag-Pt alloys 173 general structure Ag-pt alloys 173 general structure Ag-pt alloys 173 general structure Ag-pt alloys 173, 176 general structure Ag-pt alloys 173, 176 general structure Tantatum Base: 177 general structure 164 grain boundaries and inclusions grain boundaries—retains carbide precipitate 158 general structure grain boundaries—retains carbide precipitate 170 general structure 185 general structure 181 general structure 182, 183, 74 general structure 183 general structure 184 general structure 184 general structure 184 general structure 184 general structure 185 general structure 186 187, 67, 68, 69, 217 general structure 186 187, 67, 68, 69, 217 general structure 186 189 general structure 189 general structure 189 general structure 180		73b	etch-polishing for viewing grains with polarized li
Ag alloys Ag-Cu alloys Ag-Pd alloys Ag-Pa-Alloys Ag-Pa-Al			
Ag-Cu alloys Ag-Pd alloys Ag solders Tantalum Base: Pure Ta Tan alloys Thorium Base: Pure Th The alloys To	Pure Ag	172, 173, 62	general structure
Ag-Pd alloys	Ag alloys	65, 61, 174, 175, 62	general structure
Ag solders 173, 176 general structure Tantalum Base: 177 general structure Pure Ta 159, 66, 178, 163, 161, 179 general structure 164 grain boundaries and inclusions grain boundaries—retains carbide precipitate Thorium Base: Pure Th 185 general structure Tin Base: 9 general structure Pure Sn 74d, 180, 151 general structure Sn-Cd 74d general structure Sn-Fe 74d, 177a general structure Sn-Fe 74d, 177a general structure Sn-Pb 182, 183, 74b general structure Sn coatings (on stell) 183 general structure Babbitts 184 general structure Babbitts 184 general structure Fure Ti 186, 187, 67, 68, 69, 217 general structure Ti-5 Al-2,5 Sn 189 removes stain Ti-6 Al-6 V-2 Sn 190 Stains alpha and transformed beta, retained beta reveals hydrides Ti-8Mn 192 general structure <td>Ag-Cu alloys</td> <td>130</td> <td>general structure</td>	Ag-Cu alloys	130	general structure
Tantalum Base: Pure Ta			general structure
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158 grain boundaries—retains carbide precipitate Thonium Base: Pure Th	Ta alloys		
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Sn-Cd 74d general structure Sn-Fe 74d, 177a general structure Sn-Pb 182, 183, 74b general structure 116 darkens Pb in Sn-Pb eutectic Sn coatings (on steel) 183 general structure Babbitts 184 general structure Sn-Sb-Cu 74b general structure Titanium Base: Pure Ti 186, 187, 67, 68, 69, 217 general structure Pure Ti 188 removes stain 15-5 Al-2,5 Sn 189 reveals hydrides Ti-6 Al-6 V-2 Sn 190 Stains alpha and transformed beta, retained beta mains white Ti-Al-Zr 191 general structure Ti-8Mn 192 general structure Ti-3 V-11 Cr-3 Al (aged) 192 general structure Ti-Si 193 general structure Ti alloys 186, 187, 192, 194, 158, 132b, 1c, 67, general structure 68, 69, 3a, 218 11, 1c reveals alpha case 72, 192, 178 chemical polish and etch 170a	r dro on		
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Sn-Pb			•
116 darkens Pb in Sn-Pb eutectic general structure		· ·	9
Babbitts 184 general structure			
Sn-Sb-Cu 74b general structure	Sn coatings (on steel)	183	general structure
Titanium Base: Pure Ti 186, 187, 67, 68, 69, 217 188 removes stain 72 chemical polish and etch reveals hydrides Ti-5 Al-2,5 Sn Ti-6 Al-6 V-2 Sn 190 Stains alpha and transformed beta, retained beta mains white Ti-Al-Zr Ti-8Mn 192 general structure fe8, 69, 3a, 218 11, 1c reveals alpha case chemical polish and etch outlines and darkens hydrides in some alloys removes stain	Babbitts	184	general structure
Pure Ti	Sn-Sb-Cu	74b	general structure
Ti-5 Al-2,5 Sn Ti-6 Al-6 V-2 Sn Ti-6 Al-6 V-2 Sn Ti-8 Mn Ti-13 V-11 Cr-3 Al (aged) Ti-Si T	Titanium Base:		
188 removes stain 72 chemical polish and etch 75 Al-2,5 Sn Ti-5 Al-2,5 Sn Ti-6 Al-6 V-2 Sn Ti-6 Al-6 V-2 Sn Ti-6 Al-6 V-2 Sn Ti-8 Intervent Stain Ti-8 Intervent Stain Ti-8 Intervent Stain Ti-13 V-11 Cr-3 Al (aged) Ti-13 V-11 Cr-3 Al (aged) Ti-Si	Pure Ti	186, 187, <i>67, 68, 69</i> , 217	general structure
Ti-5 Al-2,5 Sn Ti-6 Al-6 V-2 Sn Ti-6 Al-6 V-2 Sn Ti-6 Al-6 V-2 Sn Ti-6 Al-6 V-2 Sn Ti-Al-Zr Ti-8Mn Ti-3 V-11 Cr-3 Al (aged) Ti-Si Ti alloys Ti all			removes stain
Ti-6 Al-6 V-2 Sn 190 Stains alpha and transformed beta, retained beta mains white Ti-Al-Zr Ti-BMn 192 Ti-13 V-11 Cr-3 Al (aged) Ti-Si Ti alloys 186, 187, 192, 194, 158, 132b, 1c, 67, 68, 69, 3a, 218 11, 1c 72, 192, 178 188 Stains alpha and transformed beta, retained beta mains white general structure general structure general structure general structure general structure general structure reveals alpha case chemical polish and etch outlines and darkens hydrides in some alloys removes stain			
Ti-Al-Zr Ti-BMn Ti-BMn Ti-Si Ti-Si Ti-alloys Ti-Si T			,
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Ti-13 V-11 Cr-3 Al (aged) Ti-Si Ti alloys 186, 187, 192, 194, 158, 132b, 1c, 67, 68, 69, 3a, 218 11, 1c 72, 192, 178 170a 188 188 general structure general structur	Ti-8Mn	192	<u> </u>
Ti-Si Ti alloys 186, 187, 192, 194, 158, 132b, 1c, 67, general structure 68, 69, 3a, 218 11, 1c reveals alpha case 72, 192, 178 chemical polish and etch 170a outlines and darkens hydrides in some alloys 188 removes stain	Ti-13 V-11 Cr-3 Al (aged)	192	
68, 69, 3a, 218 11, 1c reveals alpha case 72, 192, 178 chemical polish and etch 170a outlines and darkens hydrides in some alloys 188 removes stain			general structure
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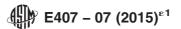


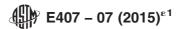
	TABLE I Communed			
Metal	Etchants	Uses		
Pure W	98c, <i>131</i>	general structure		
As cast	132a	chemical polish prior to etching		
W-Th	209	general structure		
		g		
Uranium Base:				
Pure U	67, <i>69, 195, 196</i>	general structure		
U + Zr	68	general structure		
U beryllides	170a	general structure		
U alloys	67, 69, 195, 96	general structure		
	207	carbides		
Vanadium Base:				
Pure V	170b, <i>165b</i>	general structure		
	<i>197</i> , 198	grain boundaries		
V alloys	199, 198	general structure		
Zinc Base:				
Pure Zn	200a	general structure		
Zn-Co	177	general structure		
Zn-Cu	201	general structure		
	203	distinguishes gamma (γ) and epsilon (ε)		
Zn-Fe	74a	structure of galvanized sheet		
Die castings	202	general structure		
Zirconium Base:	66, <i>67</i> , 204, 68, 69, 205	general structure		
	206	electrolytic polish and etch		
	71	grain structure under polarized light		
	72	chemical polish and etch		



TABLE 2 Numerical List of Etchants

Note 1—It is strongly recommended to always mix and use etchants under a certified and test fume hood.

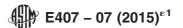
Etchant	Composition	Procedure
1	1 mL HF 200 mL water	(a) Swab with cotton for 15 s.(b) Alternately immerse and polish several minutes.(c) Immerse 3–5 s.
		(d) Immerse 10–120 s.
2	3 mL HF 100 mL water	(a) Swab 10 s to reveal general structure. (b) Immerse 15 min, wash 10 min in water to form film with hatching which varies with grain orientation.
3	2 mL HF	(a) Immerse 10–20 s Wash in stream of warm water. Reveals general structure.
	3 mL HCl	(b) Dilute with 4 parts water-colors constituents—mix fresh.
	5 mL HNO ₃	
	190 mL water	
4	24 mL $\rm H_3~PO_4$	Electrolytic: Use carbon cathode raising d-c voltage from 0–30 V in 30 s. Total etching time 3 min
	50 mL Carbitol (diethylene glycol monoethyl ether)	with agitation. Wash and cool. Repeat if necessary.
	4 g boric acid	
	2 g oxalic acid	
	10 mL HF	
	32 mL water	
_		
5	5 g HBF₄ 200 mL water	Electrolytic: Use Al, Pb, or stainless steel cathode. Anodize 1–3 min, 20–45 V d-c. At 30 V, etch for 1 min.
6	25 mL HNO ₃ 75 mL water	Immerse 40 s at 70°C (160°F). Rinse in cold water.
7	10–20 mL ${ m H_2~SO_4}$	Immerse 30 s at 70°C (160°F). Rinse in cold water.
	80 mL water	
8	10 ml H BO	(a) Immerse 1–3 min at 50°C (120°F).
0	10 mL $ m H_3~PO_4$ 90 mL water	(a) Infinerse 1–3 min at 50 C (120 F). (b) Electrolytic at 1–8 V for 5–10 s.
		(4) =:
9	3-4 g sulfamic acid	Use just prior to the last polishing operation. It is not intended as a final etchant. The
	5 drops HF	specimen is examined as polished under polarized light.
	100 mL water	
10	10 1 115	l
10	10 mL HF 90 mL methanol (90 %)	Immerse 10–30 s.
	90 IIIL Methanol (90 %)	
11	2 mL HF	Immerse or swab few seconds to a minute.
	100 mL water	
12	20 mL HNO ₃	Use a certified and tested hood. Do not store. Immerse or swab 5-60 s.
	60 mL HCl	
13	10 g oxalic acid	Electrolytic at 6 V:
10	100 mL water	(a) 10–15 s.
	. oo <u>. </u>	(b) 1 min.
		(c) 2–3 s.
		Use stainless steel cathode and platinum or Nichrome connection to specimen.
	10 mL HNO ₃	Immerse few seconds to a minute.
14	00 1 1 1 (05 0/)	
14	90 mL methanol (95 %)	
	,	Use a certified and tested hood. Age before use, Immerse 5–30 s. May be used electrolyti-
14 15	15 mL HNO ₃	
	,	Use a certified and tested hood. Age before use. Immerse 5–30 s. May be used electrolytically.
	15 mL HNO ₃ 15 mL acetic acid	
15	15 mL HNO ₃ 15 mL acetic acid 60 mL HCI 15 mL water	cally.
	15 mL HNO ₃ 15 mL acetic acid 60 mL HCI 15 mL water 5–10 mL HCI	
15	15 mL HNO ₃ 15 mL acetic acid 60 mL HCI 15 mL water	cally.
15	15 mL HNO ₃ 15 mL acetic acid 60 mL HCl 15 mL water 5–10 mL HCl 100 mL water	cally. Electrolytic at 3 V for 2–10 s.
15	15 mL HNO ₃ 15 mL acetic acid 60 mL HCl 15 mL water 5–10 mL HCl 100 mL water	cally.
15	15 mL HNO ₃ 15 mL acetic acid 60 mL HCl 15 mL water 5–10 mL HCl 100 mL water	cally. Electrolytic at 3 V for 2–10 s.
15 16 17	15 mL HNO ₃ 15 mL acetic acid 60 mL HCl 15 mL water 5–10 mL HCl 100 mL water 5 mL HCl 10 g FeCl ₃ 100 mL water	cally. Electrolytic at 3 V for 2–10 s. Electrolytic at 6 V for few seconds.
15	15 mL HNO ₃ 15 mL acetic acid 60 mL HCl 15 mL water 5–10 mL HCl 100 mL water 5 mL HCl 10 g FeCl ₃	Electrolytic at 3 V for 2–10 s.



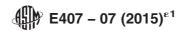
Etchant	Composition	Procedure
19	A 8 g NaOH 100 mL water B Saturated aqueous solution of KMnO ₄	Immerse in freshly mixed Solutions A + B (1:1) for 5–10 s. If surface activation is necessary, first use Etch #18, then rinse in water. While still wet, immerse in Solutions A + B (1:1). Mixture of solutions A + B has 15-min useful life. Note: $KMnO_4$ is an agressive staining agent.
20	5 mL H ₂ O ₂ (30 %) 100 mL HCl	Use a certified and tested hood. Mix fresh. Immerse polished face up for few seconds.
21	1 g CrO₃ 140 mL HCl	Use a certified and tested hood. To mix, add the HCl to ${\rm CrO_3}$. Electrolytic at 3 V for 2–10 s.
22	100 mL HCI 0.5 mL H ₂ O ₂ (30 %)	Use a certified and tested hood. Do not store. (a) Immerse or swab $\frac{1}{2}$ –3 min. Add H ₂ O ₂ dropwise to maintain action. (b) Electrolytic, 4 V, 3–5 s.
23	5 mL HCl	Electrolytic at 6 V for 10–20 s.
24	95 mL ethanol (95 %) or methanol (95 %) 5 mL HNO ₃ 200 mL HCl 65 g FeCl ₃	Use a certified and tested hood. Immerse few seconds.
25	10 g CuSO₄ 50 mL HCl 50 mL water	Immerse or swab 5–60 s. Made more active by adding few drops of $\rm H_2~SO_4$ just before use.
26	5 g FeCl ₃ 10 mL HCl 50 mL glycerol 30 mL water	Swab 16-60 s. Activity may be decreased by substituting glycerol for water.
27	1 g KOH 20 mL $\rm H_{2}$ O $_{2}$ (3 %) 50 mL $\rm NH_{4}$ OH 30 mL water	Dissolve KOH in water, then slowly add $\rm NH_4$ OH to solution. Add 3 $\%$ H $_2$ O $_2$ last. Use fresh—immerse few seconds to a minute.
28	1 g FeNO ₃ 100 mL water	Swab or immerse few seconds to a minute.
29	1 g $\mathrm{K_2Cr_2O_7}$ 4 mL $\mathrm{H_2SO_4}$ 50 mL water	Use a certified and tested hood. Add 2 drops of HCl just before using. Swab few seconds to a minute.
30	$25~\rm mL~NH_4~OH$ $25~\rm mL~water$ $50~\rm mL~H_2~O_2~(3~\%)$	$\rm Mix~NH_4~OH$ and water before adding $\rm H_2~O_2.~Must$ be used fresh. Swab 5–45 s.
31	10 g ammonium persulfate 100 mL water	 (a) Swab or immerse to 5 s. (b) Immerse to 2 min to darken matrix to reveal carbides and phosphides. (c) Electrolytic at 6 V for few seconds to a minute. (d) Immerse 3–60 s. Can be heated to increase activity.
32	60 g CrO ₃ 100 mL water	Use a certified and tested hood. Saturated solution. Immerse or swab 5–30 s.
33	10 g CrO ₃	Use a certified and tested hood. Add HCl just before use. Immerse 3–30 s. Phases can be colored by Nos. 35, 36, 37.
	2-4 drops HCI 100 mL water	
34	5 g FeCl ₃ 50 mL HCl 100 mL water	(a) Immerse or swab few seconds to few minutes. Small additions of ${\rm HNO_3}$ activate solution and minimize pitting.
		(b) Immerse or swab few seconds at a time. Repeat as necessary.
35	20 g FeCl ₃ 5 mL HCl 1 g CrO ₃ 100 mL water	Use a certified and tested hood. Immerse or swab few seconds at a time until desired results are obtained.
36	25 g FeCl ₃ 25 mL HCl 100 mL water	Immerse or swab few seconds at a time until desired results are obtained.



Etchant	Composition	Procedure
37	1 g FeCl ₃ 10 mL HCl 100 mL water	Immerse or swab few seconds at a time until desired results are obtained
38	8 g FeCl ₃ 25 mL HCl 100 mL water	Swab 5–30 s.
39	5 g FeCl ₃ 10 mL HCl 1 g CuCl ₂ 0.1 g SnCl ₂ 100 mL water	Immerse or swab few seconds at a time until desired results are obtained.
40	$5~\mathrm{g~FeCl_3}$ $16~\mathrm{mL~HCl}$ $60~\mathrm{mL}$ ethanol (95 %) or methanol (95 %)	Immerse or swab few seconds to few minutes.
41	$\begin{array}{c} \textrm{2 g K}_2\textrm{Cr}_2\textrm{O}_7 \\ \textrm{8 mL H}_2\textrm{SO}_4 \\ \textrm{4 drops HCI} \\ \textrm{100 mL water} \end{array}$	Use a certified and tested hood. Add the HCl just before using. Immerse 3-60 s.
42	10 g cupric ammonium chloride 100 mL water NH₄ OH	Add $\mathrm{NH_4}$ OH to solution until neutral or slightly alkaline. Immerse 5–60 s.
43	20 mL NH ₄ OH 1 g ammonium persulfate 60 mL water	Immerse 5–30 s.
44	50 mL NH ₄ OH 20–50 mL H ₂ O ₂ (3 %) 0–50 mL water	Use fresh. Peroxide content varies directly with copper content of alloy to be etched. Immerse or swab to 1 min. Film on etched aluminum bronze removed by No. 82.
45	1 g CrO ₃ 100 mL water	Use a certified and tested hood. Electrolytic at 6 V for 3-6 s. Use aluminum cathode.
46	15 mL $\mathrm{NH_4}$ OH 15 mL $\mathrm{H_2}$ $\mathrm{O_2}$ (3 %) 15 mL water 4 pellets NaOH	When mixing, add NaOH pellets last. For best results use before pellets have dissolved.
47	5 g NaCN or KCN 5 g (NH ₄) ₂ S ₂ O ₂ 100 mL water	Use a certified and tested hood—Can give off extremely poisonous hydrogen cyanide. Precaution—Also poisonous by ingestion as well as skin contact.
48	10 g NaCN 100 mL water	Use a certified and tested hood—Can give off extremely poisonous hydrogen cyanide. Precaution—Also poisonous by ingestion as well as skin contact. Electrolytic at 6 V: (a) 5 s for sigma. (b) 30 s for ferrite and general structure. (c) to 5 min for carbides.
49	$3 ext{ g FeSO}_4$ $0.4 ext{ g NaOH}$ $10 ext{ mL H}_2 ext{ SO}_4$ $190 ext{ mL water}$	Electrolytic at 8–10 V (0.1 A) for 5–15 s.
50	5 mL acetic acid 10 mL HNO ₃ 85 mL water	Use a certified and tested hood. Do not store. Electrolytic at 1.5 V for 20 to 60 s. Use planum wires.
51	2 g FeCl ₃ 5 mL HCl 30 mL water 60 mL ethanol or methanol	Immerse few minutes.
52	1 g sodium dichromate 1 g NaCl 4 mL $\rm H_2~SO_4$ 250 mL water	Swab few seconds.
53	1–5 mL NH_4 OH 100 mL water	Immerse 5–60 s.



Etchant	Composition	Procedure
54	1 g ammonium acetate 3 g sodium thiosulfate 7 mL NH ₄ OH 1300 mL water	Electrolytic at 0.3 A/cm ² for 5–30 s.
55	1 mL $\rm H_2~SO_4$ 15 mL $\rm HNO_3$ 10 mL acetic acid 5 mL $\rm H_3~PO_4$ 20 mL lactic acid	Use a certified and tested hood. Swab gently 10–15 s. Rinse with methanol and blow dry Helps to chemically polish. If final etch is too mild, follow with No. 98. Do not store.
56	$30~\mathrm{mL}~\mathrm{HNO_3}$ $10~\mathrm{mL}~\mathrm{H_3}~\mathrm{PO_4}$ $20~\mathrm{mL}$ acetic acid $10~\mathrm{mL}$ lactic acid	Use a certified and tested hood. Swab gently 5–15 s. Rinse with ethanol or methanol and blow dry. Do not store.
57	75 mL acetic acid 25 mL $\rm H_2~O_2$ (30 %)	Use a certified and tested hood. Immerse 6–15 s. Do not store.
58	25 mL HF 25 mL HNO ₃ 5 mL water	Swab 3–20 s.
59	2 g AgNO ₃ 40 mL water 40 mL HF	$\rm Mix~AgNO_3$ and water, then add HF and $\rm HNO_3.~Swab~1\!\!/_2~-2~min.$
60	20 mL HNO ₃ 25 mL HNO ₃ 15 mL acetic acid 15 mL province	Use a certified and tested hood. Do not store. Let stand ½ h before using. Swab 3-20 s.
61	5-7 drops bromine 60 mL HCl 40 mL HNO ₃	Use a certified and tested hood. Immerse few seconds to a minute.
62	1–5 g CrO ₃ 100 mL HCl	Use a certified and tested hood. Vary composition of reagent and aging of reagent after mixing to suit alloy. Swab or immerse few seconds to a minute.
63	0.1 g CrO ₃ 10 mL HNO ₃ 100 mL HCl	Use a certified and tested hood. Swab few seconds to a minute.
64	5 mL HNO ₃ 25 mL HCl 30 mL water	(a) Immerse 1–5 min. (b) Use hot. Will form chloride film on gold alloys if much silver is present. Ammonia will remove film.
65	A 10 g ammonium persulfate 100 mL water B 10 g KCN 100 mL water	Use a certified and tested hood—Can give off extremely poisonous hydrogen cyanide. Precaution—Also poisonous by ingestion as well as skin contact. Mix 1 + 1 mixture of Solutions A and B just before use. (A mixture of 5 drops of each will cover the surface of a 1 in. dia. mount.) Immerse ½ – 2 min.
66	30 mL HF 15 mL HNO ₃ 30 mL HCl	Use a certified and tested hood. Swab 3-10 s or immerse to 2 min.
67	10 mL perchloric acid 10 mL 2-butoxyethanol 70 mL ethanol (95 %) 10 mL water	Use in wash down/perchloric rated fume hood. Precaution—Keep cool when mixing and use. Electrolytic at 30–65 V for 10–60 s.
68	3 mL perchloric acid 35 mL 2-butoxyethanol 60 mL methanol (absolute)	Use in wash down/perchloric rated fume hood. Precaution—Keep cool when mixing and use. Electrolytic at 60–150 V for 5–30 s.
69	5 mL perchloric acid 80 mL acetic acid	Use in wash down/perchloric rated fume hood. Precaution—Keep cool when mixing and use. Electrolytic at 20–60 V for 1–5 min. Do not store.
70	5 mL HF 2 mL AgNO $_3$ (5 %) 200 mL water	Swab for 5–60 s.
71	5 mL HF 95 mL water	Add 5–10 drops of this solution on the final polishing wheel which has been charged with the polishing solution. The specimen is polished on this wheel until the surface turns black Distilled water is then slowly added to the wheel and polishing continued until the surface is bright. At this time the specimen should be ready for examination via polarized light. Note—Use inert substance between cloth and wheel to prevent attack of the wheel. Wea appropriate gloves.



Etchant	Composition	Procedure
72	10 mL HF 45 mL HNO ₃ 45 mL water	Swab for 5–20 s.
73	20 mL HCl 25 g NaCl 65 mL water	Electrolytic etch—use carbon cathode and platinum wire connection to specimen. (a) 6 V ac for 1 min. (b) 5 V-20 V ac for 1-2 min. (c) 20 V ac for 1-2 min. For etch-polishing, use shorter times. After etching, water rinse, alcohol rinse, and dry.
74	1–5 mL HNO $_3$ 100 mL ethanol (95 %) or methanol (95 %)	Etching rate is increased, sensitivity decreased with increased percentage of HNO ₃ . (a) Immerse few seconds to a minute. (b) Immerse 5–40 s in 5 % HNO ₃ solution. To remove stain, immerse 25 s in 10 % HCl-methanol solution. (c) For Inconels and Nimonics, use 5 mL HNO ₃ solution—electrolytic at 5–10 V for 5–20 s (d) Swab or immerse several minutes. (e) Swab 5–60 s. HNO ₃ may be increased to 30 mL in methanol only depending on alloy. (Ethanol is unstable with over 5 % HNO ₃ .) Do not store.
75	$5~\rm g~picric~acid$ $8~\rm g~CuCl_2$ $20~\rm mL~HCl$ $200~\rm mL~ethanol~(95~\%)~or~methanol~(95~\%)$	Immerse 1–2 s at a time and immediately rinse with methanol. Repeat as often as necessary. (Long immersion times will result in copper deposition on surface.)
76	4 g picric acid 100 mL ethanol (95 %) or methanol (95 %)	Composition given will saturate with picric acid. Immerse few seconds to a minute or more Adding a wetting agent such as zepherin chloride will increase response.
77	10 g picric acid 5 drops HCI 100 mL ethanol (95 %) or methanol (95 %)	Composition given will saturate the solution with picric acid. Immerse few seconds to a minute or more.
78	10 g potassium metabisulfite	Immerse 1–15 s. Better results are sometimes obtained by first etching lightly with No. 76 or 74.
79	100 mL water 40 mL HCl 5 g CuCl ₂ 30 mL water	Swab few seconds to a minute.
80	25 mL ethanol (95 %) or methanol (95 %) 5 mL HCl 1 g picric acid 100 mL ethanol (95 %) or methanol (95 %)	Immerse or swab few seconds to 15 min. Reaction may be accelerated by adding a few drops of 3 $\%$ H ₂ O ₂ . Optional (for prior austenite grain boundaries)—temper specimen at 600–900°F prior to preparation.
81	2 g picric acid 1 g sodium tridecylbenzene sulfonate. 100 mL water	Composition given will saturate the solution with picric acid. (a) Immerse few seconds to a minute. (b) Immerse to 15 min with occasional swabbing for heavy grain boundary attack.
82	5 g FeCl ₃ 5 drops HCl 100 mL water	Immerse 5–10 s.
83	10 g CrO ₃ 100 mL water	Use a certified and tested hood—(a) Electrolytic at 6 V for 5–60 s. Attacks carbides. (b) Electrolytic at 6 V for 3–5 s.
84	10 mL $\rm H_2~SO_4$ 10 mL $\rm HNO_3$ 80 mL water	Use a certified and tested hood. Precaution—Add $\rm H_2~SO_4$ slowly to water and cool, then add $\rm HNO_3$. Immerse 30 s. Swab in running water. Repeat three times and repolish lightly.
85	2 g picric acid 25 g NaOH 100 mL water	Use a certified and tested hood. Immerse in boiling solution for 5 min. Precaution—Do no boil dry—anhydrous picric acid is unstable and highly explosive. Alternative: Electrolytic at 6 V for 40 s (room temperature). Use stainless steel cathode.
86	3 g oxalic acid 4 mL $\rm H_2~O_2~(30~\%)$ 100 mL water	Use a certified and tested hood. Solution should be freshly prepared. Immerse 15–25 min when specimens or parts cannot be given usual metallographic polish. Multiple etching may be required.
87	$10~\mathrm{mL}$ HNO $_3$ $20-50~\mathrm{mL}$ HCl $30~\mathrm{mL}$ glycerol	Use a certified and tested hood—Can give off nitrogen dioxide gas. Precaution—Mix HCl and glycerol thoroughly before adding HNO ₃ . Do not store. Properly discard before solutio attains a dark orange color. Immerse or swab few seconds to few minutes. Higher percent age of HCl minimizes pitting. A hot water rinse just prior to etching may be used to activate the reaction. Sometimes a few passes on the final polishing wheel is also necessary to remove a passive surface.
88	10 mL HNO ₃ 20 mL HCl 30 mL water	Use a certified and tested hood—Can give off nitrogen dioxide gas. Precaution—Properly discard before solution attains a dark orange color. Immerse few seconds to a minute. Much stronger reaction than No. 87.



Etaba ant		BLE 2 Continued
Etchant	Composition	Procedure
89	10 mL HNO ₃ 10 mL acetic acid 15 mL HCl 2–5 drops glycerol	Use a certified and tested hood. Do not store. Immerse or swab few seconds to few minutes.
90	10 mL HNO ₃ 20 mL HF 20–40 mL glycerol	Use a certified and tested hood—Immerse 2–10 s. Do not store. Properly discard after use. Solution decomposes on standing.
91	$5~\rm mL~HNO_3$ $5~\rm mL~HCl$ 1 g picric acid 200 mL ethanol (95 %) or methanol (95 %)	This etchant is equivalent to a 1 + 1 mixture of No. 80 and No. 74 (5 $\%$ HNO $_{\!3}).$ Swab for 30 s or longer.
92	10 mL HCl 100 mL ethanol (95 %) or methanol (95 %)	Immerse 5-30 min or electrolytic at 6 V for 3-5 s.
93	concentrated HNO ₃	Use a certified and tested hood. Electrolytic at 0.2 A/cm² for few seconds.
94	$2~{\rm g~CuCl_2}$ $40~{\rm mL~HCl}$ $40–80~{\rm mL}$ ethanol (95 %) or methanol (95 %)	Submerged swabbing for few seconds to several minutes. Attacks ferrite more readily than austenite.
95	$2~{\rm g~CuCl_2}$ $40~{\rm mL~HCl}$ $40{\rm –80~mL}$ ethanol (95 %) or methanol (95 %) $40~{\rm mL}$ water	Immerse or swab few seconds to few minutes.
96	85 g NaOH 50 mL water	Electrolytic at 6 V for 5–10 s.
97	45 g KOH 60 mL water	Composition of solution is approximately 10 N. Electrolytic at 2.5 V for few seconds. Stains sigma and chi yellow to red brown, ferrite gray to blue gray, carbides barely touched, austenite not touched.
98	10 g K ₃ Fe(CN) ₆ [†] 10 g KOH or NaOH 100 mL water	Use a certified and tested hood—Can give off extremely poisonous hydrogen cyanide. Precaution—Also poisonous by ingestion as well as skin contact. Use fresh. (a) Immerse or swab 15–60 s. Stains carbides and sigma. (To differentiate, No. 31 electrolytic at 4 V will attack sigma, but not carbides. If pitting occurs, reduce voltage.) (b) Immerse in fresh, hot solution 2–20 min. Stains carbides dark, ferrite yellow, sigma blue. Austenite turns brown on overetching. (c) Swab 5–60 s. (Immersion will produce a stain etch). Follow with water rinse, alcohol rinse, dry.
99	25 mL HCl 3 g ammonium bifluoride 125 mL water few grains potassium metabisulfite	Mix fresh. (For stock solution, mix first three items. Add potassium metabisulfite just before use.) Immerse few seconds to a few minutes.
100	10 g FeCl ₃ 90 mL water	Immerse few seconds.
101	$2~{\rm g~CrO_3}$ 20 mL HCl 80 mL water	Use a certified and tested hood-Immerse 5–60 s. ($\rm CrO_3$ may be increased up to 20 g for difficult alloys. Staining and pitting increase as $\rm CrO_3$ increased.)
102	concentrated NH ₄ OH	Use a certified and tested hood. Electrolytic at 6 V for 30-60 s. Attacks carbides only.
103	20 mL HNO ₃ 4 mL HCl 20 mL methanol (99 %)	Use a certified and tested hood. Immerse 10-60 s.
104	$5~\mathrm{mL~HNO_3}$ $45~\mathrm{mL~HCl}$ $50~\mathrm{mL~water}$	Use a certified and tested hood. Immerse 10 min or longer.
105	$\begin{array}{c} 5 \text{ mL H}_2 \mathrm{SO}_4 \\ 3 \text{ mL HNO}_3 \\ 90 \text{ mL HCI} \end{array}$	Use a certified and tested hood. Precaution—add $\rm H_2~SO_4$ slowly to HCl with stirring, cool; then add HNO $_3$. Properly discard when dark orange color. Swab 10–30 s.
106	$7~\mathrm{mL~HNO_3}$ 25 $\mathrm{mL~HCl}$ 10 $\mathrm{mL~methanol}$ (99 %)	Use a certified and tested hood—Use fresh to avoid pitting. Immerse or swab 10-60 s.



		BLE 2 Continued
Etchant	Composition	Procedure
107	10 mL H ₃ PO ₄ 50 mL H ₂ SO ₄ 40 mL HNO ₃	Use a certified and tested hood. Precaution—Mix H ₃ PO ₄ and HNO ₃ thoroughly, then add H ₂ SO ₄ slowly with stirring. Use fresh, but allow to cool. Electrolytic at 6 V for few seconds. Brown discoloration will form at edges of specimen. To slow reaction, add water (to 100 mL) very carefully with stirring. Attacks bakelite mounts.
108	3–10 mL H ₂ SO ₄ 100 mL water	Electrolytic at 6 V for 5–10 s. Tends to pit with longer times.
109	50 mL HCl 25 mL HNO ₃ 1 g CuCl ₂ 150 mL water	Make fresh but allow to stand 30 min to avoid plating out copper. Immerse few seconds to a few minutes.
110	$$10~\rm{mL}$ HCl $$5~\rm{mL}$ HNO $_3$ 85 mL ethanol (95 %) or methanol (95 %)	Immerse to several minutes until deeply etched. Follow with light repolish.
111	$\begin{array}{c} 5~\text{mL H}_2~\text{SO}_4 \\ 8~\text{g CrO}_3 \\ 85~\text{mL H}_3~\text{PO}_4 \end{array}$	Use a certified and tested hood. Electrolytic at 10 V (0.2 A/cm²) for 5–30 s. Reveals Ti- and Cb-rich areas at a faster rate than grain boundaries.
112	60 mL acetic acid 30 mL $\mathrm{H_2~O_2}$ (30 %)	Use a certified and tested hood. Immerse 8-15 s.
113	15 mL acetic acid 15 mL HNO ₃ 60 mL glycerol	Use a certified and tested hood. Do not store. Use fresh solution at 80°C (176°F).
114	15 mL acetic acid 20 mL HNO $_{\rm 3}$ 80 mL water	Use a certified and tested hood. Use fresh solution at 40–42°C (104–108°F). Immerse 4–30 min depending on depth of worked metal layer. Clean with cotton in running water. Do not store.
115	100 mL acetic acid 10 mL $\mathrm{H_2~O_2}$ (30 %)	Use a certified and tested hood. Immerse 10–30 min depending on depth of worked metal layer. Clean in ${\rm HNO_3}$ if necessary.
116	5-10 g AgNO ₃ 90 mL water	Swab.
117	10 mL HCl 90 mL water	(a) Immerse for ½ –5 min. Follow with electrolytic etch at low current density in same solution. If specimen has considerable surface flow, immerse in concentrated HCl for a few seconds, then follow above procedure. (b) Immerse for ½ –2 min.
118	1 mL HNO ₃ 75 mL diethylene glycol 25 mL water	Swab 3–5 s for F and T6, 1–2 min for T4 and O temper.
119	1 mL HNO ₃ 20 mL acetic acid 60 mL diethylene glycol 20 mL water	Use a certified and tested hood. Swab 1–3 s for F and T6, 10 s for T4 and O temper. Do not store.
120	10 mL HF 90 mL water	Immerse with gentle agitation 3-30 s.
121	0.7 mL H ₃ PO ₄ 4 g picric acid 100 mL ethanol (95 %) or methanol (95 %)	Composition critical. (a) Immerse with gentle agitation 10–30 s. (b) To increase staining immerse and withdraw with a meniscus layer. Lightly apply etchant over surface until dark stain develops.
122	2 g oxalic acid 100 mL water	Swab.
123	$60~\text{mL}~\text{H}_3~\text{PO}_4$ 100 mL ethanol (95 %)	Electrolytic: Use stainless steel cathode. Space electrodes 2 cm apart. Start at 3 V dc. After 30 s maintain at $1\frac{1}{2}$ V.
124	5 mL acetic acid 10 mL water 6 g picric acid 100 mL ethanol (95 %) or methanol (95 %)	Use a certified and tested hood. Immerse with gentle agitation 10-60 s.
125	10 mL acetic acid 6 g picric acid 100 mL ethanol (95 %) or methanol (95 %)	Use a certified and tested hood. Immerse with gentle agitation 15-30 s.
126	30 mL acetic acid 15 mL water 6 g picric acid 100 mL ethanol (95 %) or methanol (95 %)	Use a certified and tested hood. Immerse with gentle agitation 1-30 s.

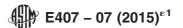


	TABLE 2 Continued				
Etchant	Composition	Procedure			
127	20 mL acetic acid 20 mL water 3 g picric acid 50 mL ethanol (95 %) or methanol (95 %)	Use a certified and tested hood. Immerse with gentle agitation 5–30 s.			
128	8 mL HF 5 mL HNO ₃ 200 mL water	Use a certified and tested hood. Immerse with gentle agitation 5-15 s.			
129	10 mL HF 30 mL HNO $_{\rm 3}$ 60 mL lactic acid	Swab 10-20 s. Vary HF to increase or decrease activity.			
130	25 mL HCl 75 mL methanol	Caution—Keep below 24°C (75°F). Electrolytic at 30 V for 30 s.			
131	$5~\mathrm{mL~H_2~SO_4}$ $1~\mathrm{mL~HF}$ 100 mL methanol (95 %)	Use a certified and tested hood. Electrolytic at 50-60 V for 10-20 s.			
132	5 mL HF 10 mL HNO ₃ 50 mL lactic acid	Use fresh. (a) Swab with heavy pressure for 5–10 s. Water rinse, alcohol rinse, dry, then etch with No. 98c. (b) Swab for 5–30 s.			
133	$50~\mathrm{mL}~\mathrm{HNO_3}$ $50~\mathrm{mL}$ acetic acid	Use a certified and tested hood. Do not store. <i>Mix fresh.</i> Immerse or swab 5 to 30 s. Will chemically polish with longer times. Sulfidized grain boundaries etched before normal grain boundaries. Do not store.			
134	70 mL H ₃ PO ₄ 30 mL water	Electrolytic 5–10 V for 5–60 s. (Polishes at high currents.)			
135	$80~\mathrm{mL~HNO_3}$ 3 mL HF	Use a certified and tested hood. Warm specimen in boiling water prior to immersion for 10 to 120 s.			
136	20 mL H ₃ PO ₄ 80 mL water	Electrolytic at 10-20 V for 10-15 s.			
137	10 g NaNO ₃ 100 mL water	Electrolytic, 0.2 A/cm ² , 1 min.			
138	5 g FeCl $_{\rm 3}$ 2 mL HCl 100 mL ethanol (95 %) or methanol (95 %)	Swab 10-60 s.			
139	5 g KCN 100 mL water 0.5 mL H ₂ O ₂ (3 %)	Use a certified and tested hood—Can give off extremely poisonous hydrogen cyanide. Precaution—Also poisonous by ingestion as well as skin contact. Immerse 10–100 s.			
140	50 mL acetic acid 50 mL HNO ₃ 50 mL acetone	Use a certified and tested hood. Do not store. Decomposes with possible explosion on standing. Immerse 10–30 s.			
141	3 g NH ₄ Cl 3 g CrO ₃ 10 mL HNO ₃ 90 mL water	Use a certified and tested hood-Swab 5-30 s. Do not store.			
142	5 mL HF 10 mL glycerol 85 mL water	Electrolytic at 2–3 V for 2–10 s.			
144	A 10 g sodium thiosulfate 100 mL water B 10 mL HCI	Electrolytic in Solution A: specimen is cathode, 10 V, 5–10 s. Then electrolytic in Solution B: specimen is anode, 10 V, 5–10 s.			
145	90 mL water $2 \text{ mL H}_2 \text{ SO}_4$ 100 mL water	Electrolytic at 3–10 V for 5–15 s. Use platinum wires. $\rm H_2~SO_4$ may be increased to 20 mL for deeper attack.			
146	10 mL HF 100 mL HNO $_{\mathrm{3}}$	Immerse 30 s–3 min.			
147	20 mL HNO ₃ 80 mL HCl	Immerse 5–30 s.			

	IADLE 2 Continued			
Etchant	Composition	Procedure		
148	5 mL HNO ₃	Immerse 10–30 s.		
	100 mL water			
	50 1 1101			
149	50 mL HCl 2 mL H ₂ O ₂ (30 %)	Immerse 10–30 s. Do not store.		
	50 mL water			
	00 m2 maio.			
150	60 mL HCI	Use a certified and tested hood. Do not store. Swab few seconds to a minute. Proper		
	20 mL HNO ₃	discard when solution turns dark yellow.		
	40 mL glycerol			
151	10 mL HF	Swab 5-30 s.		
	25 mL HNO ₃			
	150 mL water			
152	95 ml NH OH	Use a certified and tested hood. Immerse 5–15 s. Do not store—Decomposes.		
152	85 mL NH ₄ OH 15 mL H ₂ O ₂ (30 %)	ose a certified and tested flood. Infinierse 5-15 s. Do flot store—Decomposes.		
	10 1112 112 02 (00 70)			
153	10 mL HNO ₃	Use a certified and tested hood. Do not store. Add HNO ₃ last. Properly discard when date		
	50 mL HCI	yellow. Immerse 10-60 s. Preheating specimen in boiling water hastens reaction.		
	60 mL glycerol			
154	50 mL HCl	Immerse 10-100 s.		
	50 mL ethanol (95 %) or methanol (95 %)			
155	3 mL selenic acid	Use a certified and tested hood. Immerse 1–15 min. (Up to 30 mL of HCl may be used		
	10 mL HCl 100 mL ethanol (95 %) or methanol (95 %)	more vigorous action.) Stable for 3–90 days, depending on HCl concentrations. Use appriate gloves.		
	100 THE Canadion (00 70) of Theatrainer (00 70)	pridic giovos.		
156	1 g thiourea	Electrolytic, 0.005-0.01 A/cm ² , 1-2 min.		
	1 mL H ₃ PO ₄			
	1000 mL water			
157	25 g CrO ₃	Use a certified and tested hood. Immerse 5-20 s.		
107	150 mL HCl	ood a doranida ana tootaa nood. Immoloo o 25 c.		
	50 mL water			
450	40 1 115	0 1545 D 11 D 1 " 1 " 01 " 1		
158	10 mL HF 10 mL HNO ₃	Swab 5–15 s. Do not store Properly discard after use. Solution decomposes on standir		
	20 mL glycerol			
159	5 mL HF	Use a certified and tested hood. Swab 10–30 s. Do not store.		
	20 mL HNO ₃ 50 mL acetic acid			
	50 IIIL acetic acid			
160	20 mL HF	Immerse to 5 min.		
	$15 \text{ mL H}_2 \text{ SO}_4$			
	5 mL HNO ₃			
	50 mL water			
161	25 mL HNO ₃	Immerse 5–120 s.		
	5 mL HF			
162	Α	Swab 1–3 min in Solution A (acts as etch polish). To etch, swab with Solution B for 5		
	50 mL lactic acid	Repeat if necessary. The HF may be varied to give more or less etching. Do not store		
	30 mL HNO ₃			
	2 mL HF			
	В			
	30 mL lactic acid			
	10 mL HNO ₃			
163	10 mL HF 30 mL H ₂ SO ₄	Immerse 5–60 s. Use this solution for alternate etch and polishing.		
	30 mL HF	g.		
	3–5 drops H ₂ O ₂ (30 %)			
104	30 mL water	Lipp a position and tested hand Owell 0.40 -		
164	50 mL HNO ₃	Use a certified and tested hood. Swab 3–10 s.		
	30 g ammonium bifluoride 20 mL water			
	Lo IIIL Water			
165	10 mL HCl	(a) Electrolytic at 10 V for 30 s. Use carbon cathode and platinum wire connection to		
	90 mL ethanol	specimen. For etch-polishing, use shorter time.		
		(b) Electrolytic at 6 V for 10 s. Use stainless steel cathode and platinum or Nichrome w		
		contact to specimen.		



Etchant	Composition	Procedure
166	A 20 g ammonium persulfate 90 mL water B	Use a certified and tested hood—Can give off extremely poisonous hydrogen cyanide. Precaution—Also poisonous by ingestion as well as skin contact. Mix 1 + 1 ratio of Solution A and B just before use. (A mixture of 5 drops of each will cover the surface of a 1 in. dia mount.) Immerse to several minutes.
	20 g KCN 90 mL water	,
167	5 g NaCN 100 mL water	Use a certified and tested hood—Can give off extremely poisonous hydrogen cyanide. Precaution—Also poisonous by ingestion as well as skin contact. Electrolytic at 1–5 V ac for 1–2 min. Use platinum cathode.
168	20 mL HCl 35 g NaCl 80 mL water	Composition given will saturate the solution with NaCl. Electrolytic at 1½ V ac for 1 min.
169	$$ 5 mL HNO $_{3}$ $$ 50 mL ethylene glycol $$ 20 mL ethanol (95 %) or methanol (95 %)	Electrolytic at 0.05 A/cm² for 2 min. Use stainless steel cathode.
170	1 mL HF 30 mL HNO ₃ 30 mL lactic acid	(a) Swab 5–30 s. Follow with water rinse, alcohol rinse, dry.(b) Swab for 10 s intervals. Increase HF to exaggerate grain boundaries.
171	concentrated HCI	Use a certified and tested hood. Electrolytic at 5 V ac for 1–2 min. For etch-polishing, use shorter times. Follow with water rinse, alcohol rinse, and dry.
172	A 5 g ammonium persulfate 100 mL water B	Use a certified and tested hood—Can give off extremely poisonous hydrogen cyanide. Precaution—Also poisonous by ingestion as well as skin contact. Prepare 1 + 1 mixture of Solutions A and B just before use. (A mixture of 5 drops of each will cover the surface of a 1 in. dia mount.) Immerse 1–2 min.
	5 g KCN 100 mL water	
173	$50~\mathrm{mL}~\mathrm{NH_4}~\mathrm{OH}$ $10-30~\mathrm{mL}~\mathrm{H_2}~\mathrm{O_2}~(50~\%)$	Immerse few seconds to a minute.
174	A $ 25 \text{ mL HNO}_3 $ 1 g K_2 Cr_2 O_7 1000 mL water $ B $ 40 g CrO_3 3 g Na_2 SO_4 200 mL water	Use a certified and tested hood. Prepare 1 + 1 mixture of Solutions A and B. Apply with camel's hair brush. Nonadherent film of silver chromate should form. If film adheres, add more of Solution A, if none forms, add Solution B.
175	$\begin{array}{c} \text{1 g CrO}_3 \\ \text{1 mL H}_2 \text{SO}_4 \\ \text{1000 mL water} \end{array}$	Use a certified and tested hood. Immerse to 1 min.
176	2 g FeCl ₃ 100 mL water	Immerse 5–30 s.
177	10 g NaOH 100 mL water	Swab or immerse 5–15 s.
178	20 mL HF 20 mL HNO ₃ 60 mL lactic acid	Swab for 5–20 s. Do not store.
179	А	Use a certified and tested hood—Mix Solution B very slowly. Solution A is used as a chemical polish, though some etching will occur. Swab 2 or more minutes for desired surface. If surface is insufficiently etched use Solution B electrolytically at ½ –1 A/in.² of specimen. Use carbon cathode and platinum wire connection to specimen. Properly discard Solution B after 1 hr. Do not store.
	10 mL HF 10 mL HNO ₃ 30 mL lactic acid	
	B 10 mL HF 90 mL H ₂ SO ₄	



TABLE 2 Continued Etchant Composition Procedure			
180	$10\ \mathrm{mL\ HNO_3}$ 30 mL acetic acid 50 mL glycerol	Use a certified and tested hood. Immerse for ½ –10 min at 38 to 42°C (100–108°F). Do not store Properly discard after use. Solution composes on standing.	
181	2 mL HCl 100 mL ethanol (95 %) or methanol (95 %)	Swab for 1–3 min.	
182	10 mL HNO ₃ 10 mL acetic acid 80 mL glycerol	Use a certified and tested hood. Immerse for $\frac{1}{2}$ –10 min at 38 to 42°C (100–108°F). Do not store. Properly discard after use. Solution decomposes on standing.	
183	2 drops HF 1 drop HNO ₃ 25 mL glycerol	Immerse for 1 min. Do not store. Properly discard after use. Solution decomposes on standing.	
184	10 g FeCl ₃ 2 mL HCI 100 mL water	Immerse for ½ –5 min.	
185	10 mL HF 10 mL HNO $_{\rm 3}$	Swab for few seconds.	
186	10 mL HF 5 mL HNO ₃ 85 mL water	Swab 3–20 s.	
187	10 mL HF 30 mL HNO ₃ 50 mL water	Swab 3–20 s.	
188	1 mL HF 2 mL HNO ₃ 50 mL H ₂ O ₂ (30 %) 50 mL water	Use a certified and tested hood. Swab until stain is removed.	
189	10 mL HF 25 mL HNO ₃ 45 mL glycerol 20 mL water	Swab 3-20 s. Do not store Properly discard after use. Solution decomposes on standing.	
190	8 g KOH 10 mL $\rm H_2~O_2~(30~\%)$ 60 mL water	Swab 3–20 s.	
191	25 mL HF 18 g benzalkonium chloride 35 mL methanol (95 %) 40 mL glycerol	Swab 3–20 s.	
192	1–3 mL HF 2–6 mL HNO ₃ 100 mL water	Swab 3–10 s or immerse 10–30 s. (HF attacks and $\rm HNO_3$ brightens the surface of titanium. Make concentration changes on this basis.)	
193	2 drops HF 1 drop HNO ₃ 3 mL HCI 25 mL glycerol	Swab 3-20 s. Do not store Properly discard after use. Solution decomposes on standing	
194	20 mL HF 20 mL HNO ₃ 60 mL glycerol	Immerse 5–30 s.Do not store Properly discard after use. Solution decomposes on standing.	
195	30 mL $\rm H_3~PO_4$ 30 mL ethylene glycol 50 mL ethanol (95 %)	Electrolytic at 18–20 V (0.03 A/cm²) for 5–15 min.	
196	18 g CrO ₃ 75 mL acetic acid 20 mL water	Use a certified and tested hood. Dissolve ${\rm CrO_3}$ in hot water and cool before adding acetic acid. Keep solution below 2°C (35°F) during use. Electrolytic at 80 V for 5–30 min. Do not store.	
197	5 g oxalic acid 100 mL water	Electrolytic at 6 V for 5–20 s.	

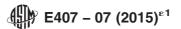


	TABLE 2 Continued			
Etchant	Composition	Procedure		
198	30 mL HF 30 mL HNO ₃ 30 mL glycerol	Swab for 60 s. Do not store. Properly discard after use. Solution decomposes on standing.		
199	$_{2}$ mL HF $_{5}$ g AgNO $_{3}$ 100 mL water	Swab for 5 s.		
200	A 40 g CrO_3 $3 \text{ g Na}_2 \text{ SO}_4$ 200 mL water 8 40 g CrO_3 200 mL water	Use a certified and tested hood. Immerse in Solution A with gentle agitation for several seconds. Rinse in Solution B.		
201	A 40 g CrO ₃ 1.5 g Na ₂ SO ₄ 200 mL water B 40 g CrO ₃ 200 mL water	Use a certified and tested hood. Immerse in Solution A with gentle agitation for several seconds. Rinse in Solution B.		
202	A 10 g CrO_3 1 g $Na_2 SO_4$ 200 mL water B 40 g CrO_3 200 mL water	Use a certified and tested hood. Immerse in Solution A for 2-5 s. Rinse in Solution B.		
203	20 g CrO ₃ 100 mL water	Use a certified and tested hood. Electrolytic at 0.2 A/cm ² for 5 s.		
204	10 mL perchloric acid 10 mL glycerol 70 mL ethanol (95 %) 10 mL water	Use in a wash down/prechloric rated fume hood. Precaution—Keep cool when mixing and use. Electrolytic at 15–50 V for 15–60 s.		
205	5 mL HF 2 mL AgNO ₃ (5 %) 100 mL water	Swab vigorously for 10–60 s. Wet cotton frequently.		
206	5 mL HF 10 mL HNO ₃ 100 mL glycerol	Precaution—Properly discard after use. Solution decomposes on standing. Electrolytic at 9–12 V for 1–10 min.		
207	$30~\mathrm{mL}$ HNO $_{3}$ $30~\mathrm{mL}$ acetic acid $30~\mathrm{mL}$ water	Swab for 5–30 s. Do not store.		
208	$1~\rm mL~NH_4~OH$ $3~\rm g$ ammonium persulfate $100~\rm mL~water$	Immerse or swab few seconds to a minute.		
209	15 mL HNO ₃ 3 mL HF 80 mL water	Immerse 5–60 s.		
210	50 mL water (cold) saturated with sodium thiosulfate 1 g potassium metabisulfite	First ingredient in stock solution. Add potassium metabisulfite before use. Solution good for several days, or longer. Immerse face up, gently agitate until coloration begins, allow to settle. Stop etch when surface is red-violet. Etch time varies with material. Colors matrix phases.		
211	3 g potassium metabisulfite 10 g sodium thiosulfate 100 mL water	Use fresh solution. Immerse specimen face up, gently agitate solution until coloration begins, allow to settle. Stop etch when surface is red-violet. Etch time varies with material. Colors matrix phases.		



Etchant	Composition	Procedure	
212	10–50 % HCl in water 0.5–1.0 g potassium metabisulfite per 100 mL of aqueous HCl solution Optional: 1 g CuCl ₂ 1–3 g FeCl ₃ 2–10 g ammonium bifluoride	For more corrosion resistant alloys. Increase the HCl and potassium metabisulfite contents. Use optional ingredients to improve coloration, if needed. Colors matrix phases. Use by immersion only.	
213	2-10 mL HCl 0.5-3 mL selenic acid 100 mL ethyl alcohol (95 %)	For more corrosion resistant alloys, increase the HCl and selenic acid content. For highly corrosion-resistant alloys, use 20–30 mL HCl. Colors second phase constituents. Use by immersion only.	
214	1 g sodium molybdate 100 mL water	Add nitric acid to lower the pH to 2.5–3. Add 0.1–0.5 g ammonium bifluoride for carbon steels. Use by immersion only. Colors carbides. Immerse about 15 s.	
215	240 g sodium thiosulfate 30 g citric acid 24 g lead acetate 1000 mL water	Mix in order given. Store in a dark bottle at least 24 h before use at 20°C. Lightly prospecimen before use. Use small portion of stock solution for 4 h max. Pre-etch steel mens with nital before tinting the MnS (add 0.2 g sodium nitrite to 100 mL of etch) v Colors phosphides in cast iron. Colors matrix of Cu alloys.	
216	8–15 g sodium metabisulfite 100 mL water	Do not store. Mix fresh. Immerse specimen face up. Agitate solution gently until coloration begins, allow to settle. Stop when surface is dark. Use crossed polarized light and sensitive tint to improve coloration.	
217	5 g ammonium bifluoride 100 mL water	Mix fresh, use plastic coated tongs and polyethylene beaker. Immerse until surface is col ored.	
218	3 g ammonium bifluoride 4 mL HCl 100 mL water	Mix fresh, use plastic coated tongs and polyethylene beaker. Immerse until surface is colored. Works best with attack-polished specimens.	
219	60 mL HNO ₃ 40 mL water	Electrolytic etch, does not reveal twins in γ stainless steel. Excellent grain boundary etch for ferritic stainless steels. Use at 1 V dc, 120 s, with stainless cathode; 0.6 V dc with plat num cathode.	
220	20 g NaOH 100 mL water	Electrolytic etch, colors δ -ferrite in stainless steels. Use at 2–20 V dc, 5–20 s, stainless steel cathode. If δ is not colored, increase NaOH to 40 g.	
221	50 mL water 50 mL ethyl alcohol 50 mL methyl alcohol 50 mL HCl 1 g CuCl ₂ 2.5 g FeCl ₃ 2.5 mL HNO ₃	Use by immersion. Will not attack sulfides in stainless steels.	
222	8 g Na ₂ SO ₄ 100 mL water	(a) Few seconds to 1 minute.(b) Pre-etch 2 s in No. 74, rinse, and etch 20 s.	
223	A 8 g oxalic acid 5 mL $\rm H_2~SO_4$ 100 mL water B $\rm H_2~O_2~(30~\%)$	Mix equal volumes of Solutions A and B just before use. Etch 2–3 s; 3 s pre-etch in No. 7 may be needed.	
224	10 mL $\rm H_2~O_2~(30~\%)$ 20 mL 10 % aqueous NaOH	Immerse 10 s at 20°C (68°F).	
225	4 g NaOH 100 mL saturated aqueous $\mathrm{KMnO_4}$	Immerse 10 s at 20°C (68°F).	
226	15 mL HCl 10 mL acetic acid 5 mL HNO ₃ 2 drops glycerol	Use a certified and tested hood.—Can give off nitrogen dioxide gas. Precaution—Mix HCl and glycerol thoroughly before adding HNO ₃ . Do not store. Properly discard before solution attains a dark orange color. Use fresh or age up to 1 min. Immerse or swab few seconds to few minutes. Can increase HNO ₃ to increase strength. Sometimes a few passes on the final polishing wheel is also necessary to remove a passive surface.	

TABLE 3 Etchant Names

Common Name	No.	Common Name	No.
Acetic glyceregia	89, 226	Groesbeck's	19
Alkaline Sodium Picrate	85	Hatch	2
Aqua regia	12	Howarth's	84
Barker's	5	Kalling's 1	95
Beraha's	99, 155, 211–215	Kalling's 2	94
Carapella	138	Keller's	3
Chrome regia	101	Klemm's	210
Contrast	141	Kroll's	192, 187
CP 4	60	Marble's	25
El-1R	107	Marshall's	223
Flat	133	Murakami's	98
Flouregia	90, 158	Nital	74
Frank's	104	Palmerton	200
Fry's	79	Phoschromic	111
G	107	Picral	76
Glyceregia	87	Ralph's	221
Gorsuch	75	Super Picral	77
Grard's No. 1	35	Vilella's	80
Green contrast	94	92-5-3	105

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